PXE30-xxDxx Dual Output DC/DC Converter

9 to 18 Vdc , 18 to 36 Vdc , or 36 to 75 Vdc input, 12 to 15 Vdc Dual Output, 30W

Features

- 30 watts maximum output power
- Output current up to 1250mA
- Standard 2" x 1.6" x 0.4" package
- High efficiency up to 88%
- 2:1 wide input voltage range
- Six-sided continuous shield
- Fixed switching frequency
- CE MARK meets 2006/95/EC, 93/68/EEC and 2004/108/EC
- UL60950-1, EN60950-1 and IEC60950-1 licensed
- ISO9001 certified manufacturing facilities
- Compliant to RoHS EU directive 2002/95/EC

Options

- Heat sinks available for extended operation

APPLICATIONS

Wireless Network
Telecom/Datacom
Industry Control System
Measurement Equipment
Semiconductor Equipment

General Description

The PXE30-xxDxx series offers 30 watts of output power in a 2 x 1.6 x 0.4 inch package . This series has a 2:1 wide input voltage of 9-18VDC, 18-36VDC or 36-75VDC and features 1600VDC of isolation, short-circuit and over-voltage protection.

Table of Contents

Absolute Maximum Rating				
Parameter	**Model**	**Min**	**Max**	**Unit**
Input Voltage Continuous Transient (100mS)	 12Dxx 24Dxx 48Dxx 12Dxx 24Dxx 48Dxx		 18 36 75 36 50 100	V_{DC}
Input Voltage Variation (complies with EST300 132 part 4.4)	All		5	V/mS
Operating Ambient Temperature (with derating)	All	-40	85	°C
Operating Case Temperature	All		100	°C
Storage Temperature	All	-55	105	°C

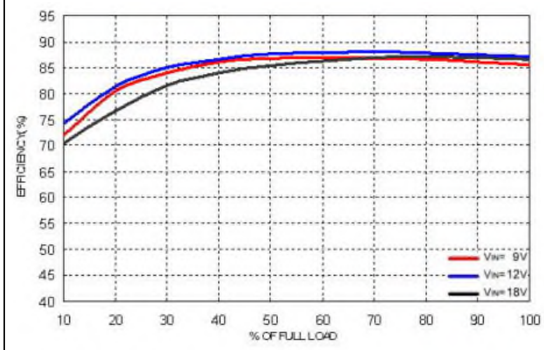
Output Specification					
Parameter	**Model**	**Min**	**Typ**	**Max**	**Unit**
Output Voltage (Vin = Vin(nom) ; Full Load ; TA=25°C)	xxD12 xxD15	11.88 14.85	12 15	12.12 15.15	V_{DC}
Voltage Adjustability	All	-10		+10	%
Output Regulation Line (Vin(min) to Vin(max) at Full Load) Load (Min. to 100% of Full Load)	All	 -0.5 -1		 +0.5 +1	%
Output Ripple & Noise Peak-to-Peak (20MHz bandwidth) (Measured with a 0.1μF/50V MLCC)	 xxD12 xxD15		 100 100		mVp-p
Temperature Coefficient	All	-0.02		+0.02	%/°C
Output Voltage Overshoot (Vin(min) to Vin(max) ; Full Load ; T_A=25°C)	All		0	5	% V_{OUT}
Dynamic Load Response (Vin = Vin(nom) ; T_A=25°C) Load step change from 75% to 100% or 100 to 75% of Full Load Peak Deviation Setting Time (V_{OUT} < 10% peak deviation)	 All All		 250 300		 mV μS
Output Current	xxD12 xxD15	0 0		±1250 ±1000	mA
Output Over Voltage Protection (Zener diode clamp)	xxD12 xxD15		15 18		V_{DC}
Output Over Current Protection	All			150	% FL.
Output Short Circuit Protection	All	Hiccup, automatic recovery			

Input Specification					
Parameter	**Model**	**Min**	**Typ**	**Max**	**Unit**
Operating Input Voltage	12Dxx 24Dxx 48Dxx	9 18 36	12 24 48	18 36 75	V_{DC}
Input Current (Maximum value at Vin = Vin(nom); Full Load)	12D12 12D15 24D12 24D15 48D12 48D15			3012 3012 1488 1488 744 744	mA
Input Standby Current (Typical value at Vin = Vin(nom); No Load)	12D12 12D15 24D12 24D15 48D12 48D15		60 40 30 30 20 20		mA
Under Voltage Lockout Turn-on Threshold	12Dxx 24Dxx 48Dxx			9 17.8 36	V_{DC}
Under Voltage Lockout Turn-off Threshold	12Dxx 24Dxx 48Dxx		8 16 33		V_{DC}
Input Reflected Ripple Current (5 to 20MHz, 12μH Source Impedance)	All		30		mAp-p
Start Up Time (Vin = Vin(nom) and Constant Resistive Load) Power Up Remote ON/OFF	All			25 25	mS
Remote ON/OFF Control (The ON/OFF pin voltage is referenced to $-V_{IN}$) Positive Logic DC-DC ON DC-DC OFF	All	3.0 0		12 1.2	V_{DC}
Remote Off Input Current	All		2.5		mA
Input Current of Remote Control Pin	All	-0.5		0.5	mA

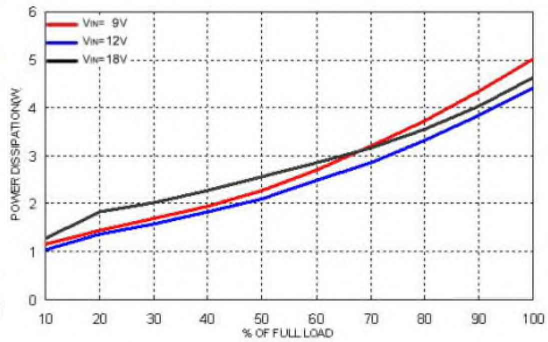
General Specification					
Parameter	**Model**	**Min**	**Typ**	**Max**	**Unit**
Efficiency (Vin = Vin(nom) ; Full Load ; TA=25°C)	12D12 12D15 24D12 24D15 48D12 48D15		87 87 88 88 88 88		%
Isolation Voltage Input to Output Input to Case, Output to Case	All	1600 1600			V_{DC}
Isolation Resistance	All	1			GΩ
Isolation Capacitance	All			1000	pF
Switching Frequency	All		300		kHz
Weight	All		48		g
MTBF Bellcore TR-NWT-000332, TC=40°C MIL-HDBK-217F	All		1.316×10^6 3.465×10^5		hours
Over Temperature Protection	All		115		°C

Characteristic Curves

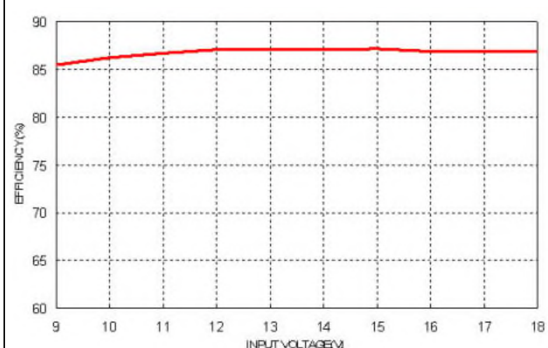
All test conditions are at 25°C.The figures are or PXE30-12D12



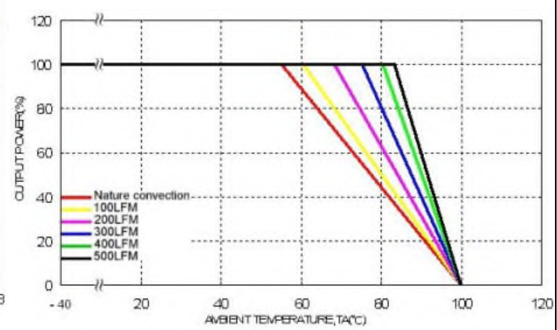
Efficiency Versus Output Current



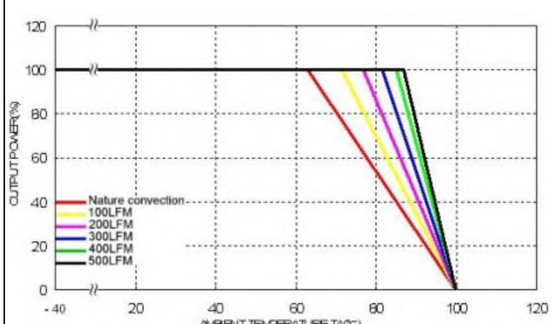
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



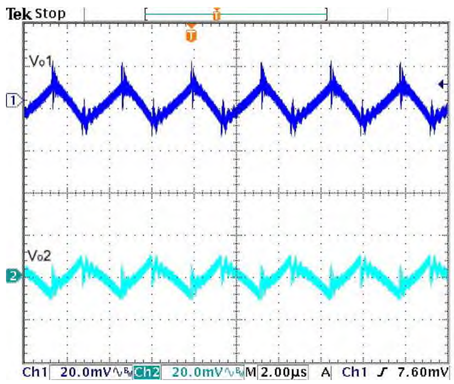
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



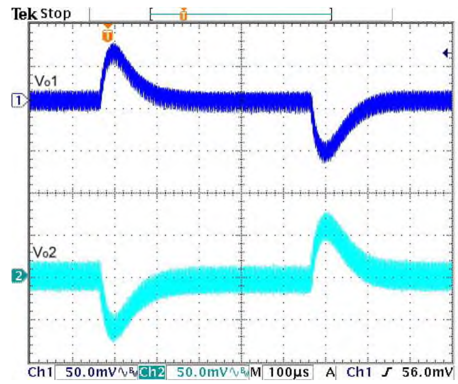
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

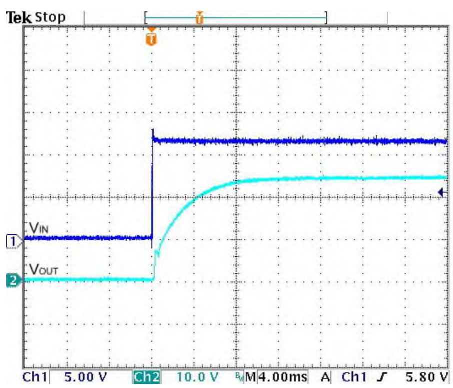
All test conditions are at 25°C.The figures are for PXE30-12D12



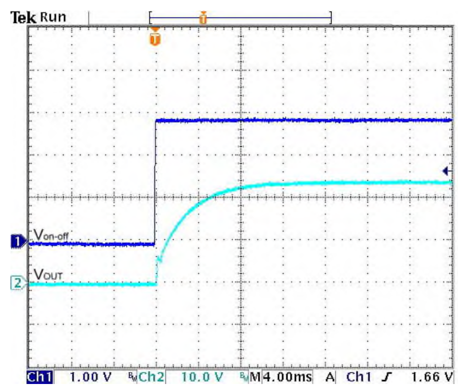
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



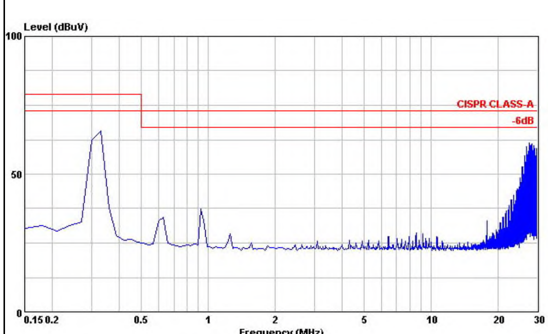
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



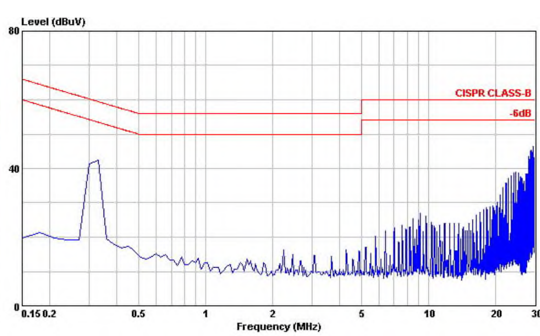
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



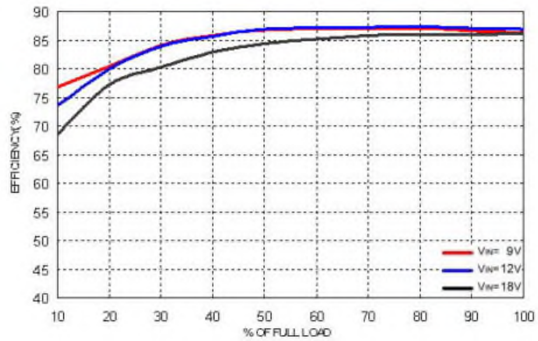
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



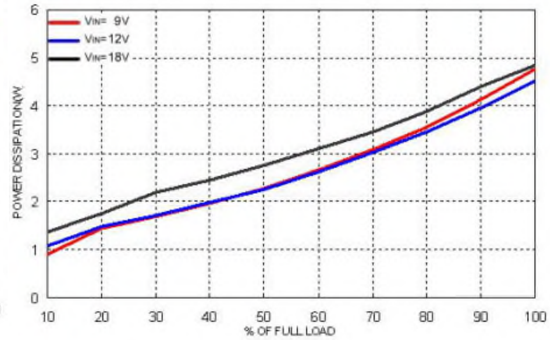
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

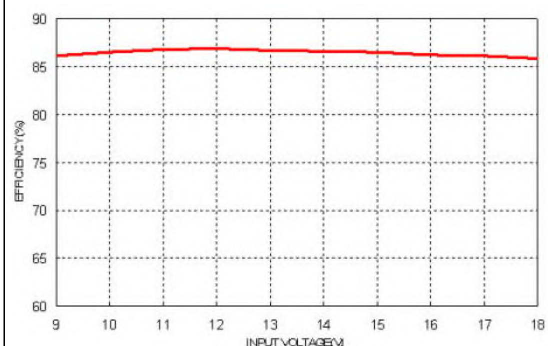
All test conditions are at 25°C.The figures are for PXE30-12D15



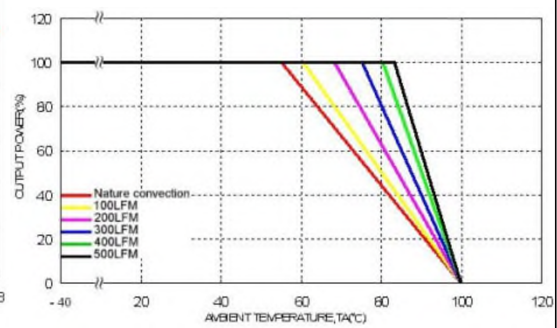
Efficiency Versus Output Current



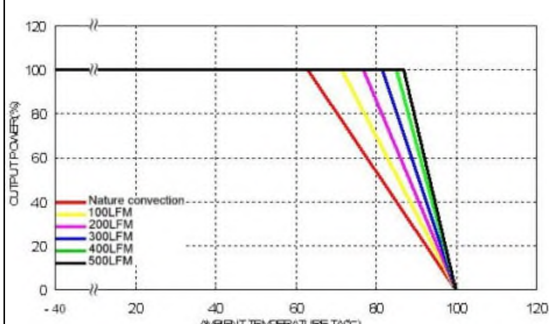
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



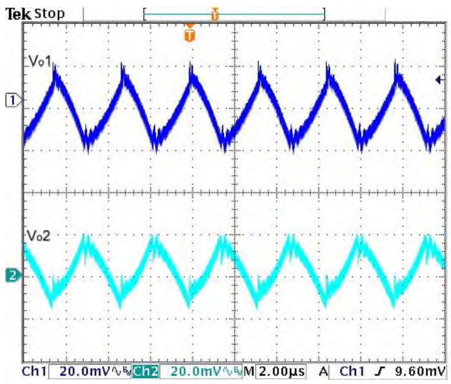
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

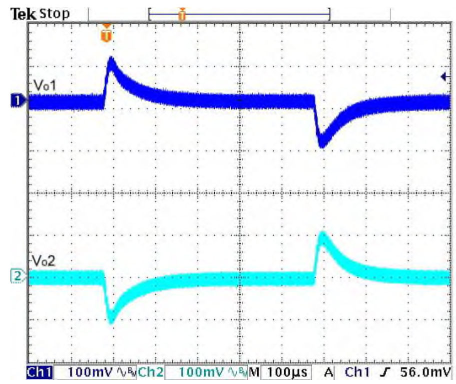
Characteristic Curves (Continued)

All test conditions are at 25°C.The figures are for PXE30-12D15



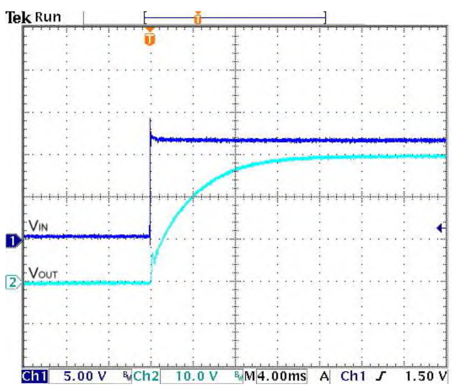
Typical Output Ripple and Noise.

Vin=Vin(nom), Full Load



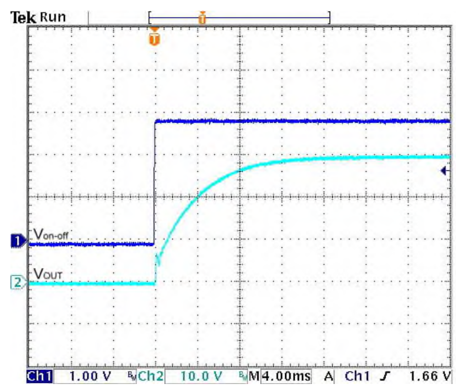
Transient Response to Dynamic Load Change from

100% to 75% to 100% of Full Load ; Vin=Vin(nom)



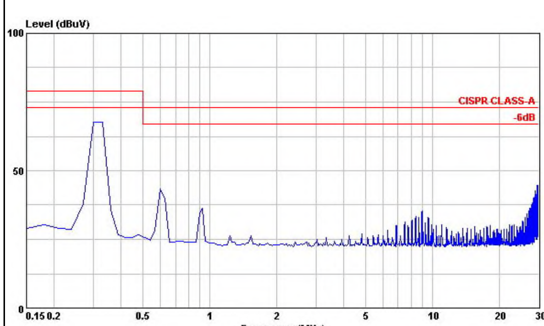
Typical Input Start-Up and Output Rise Characteristic

Vin=Vin(nom), Full Load



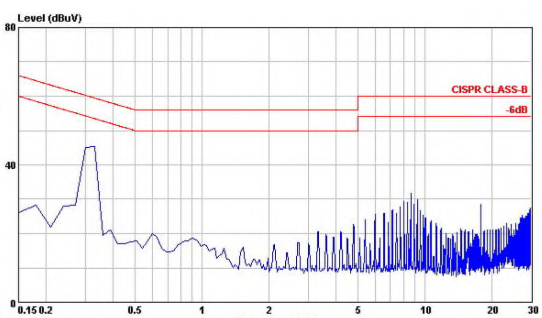
Using ON/OFF Voltage Start-Up and Vo Rise Characteristic

Vin=Vin(nom), Full Load



Conduction Emission of EN55022 Class A

Vin=Vin(nom), Full Load

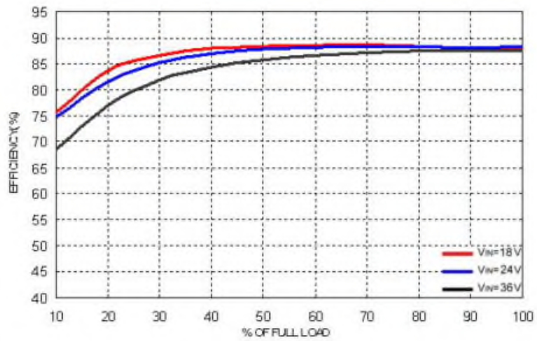


Conduction Emission of EN55022 Class B

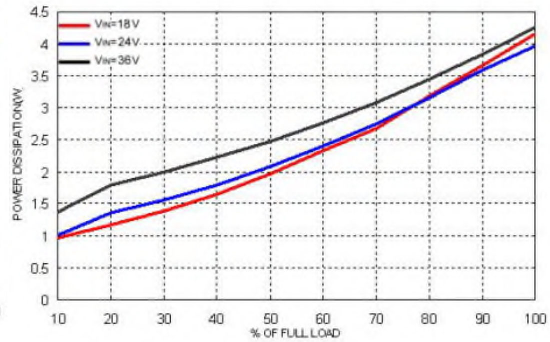
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

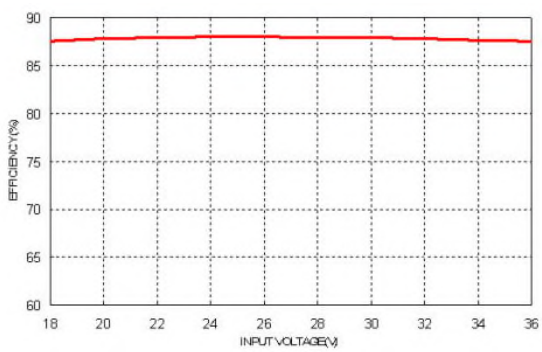
All test conditions are at 25°C.The figures are for PXE30-24D12



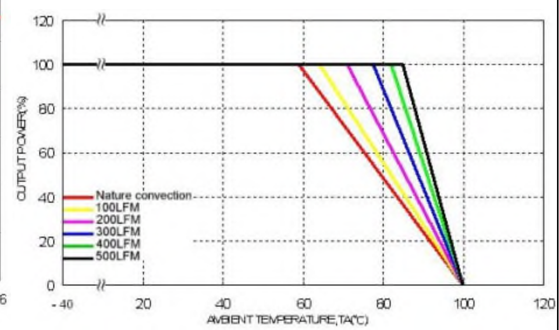
Efficiency Versus Output Current



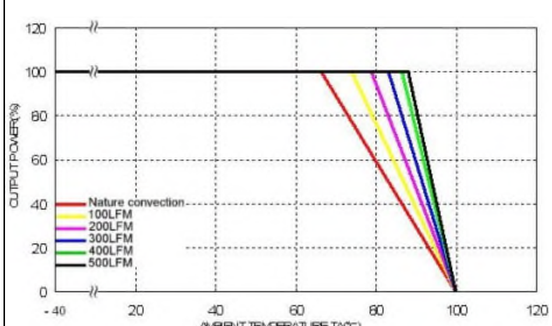
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



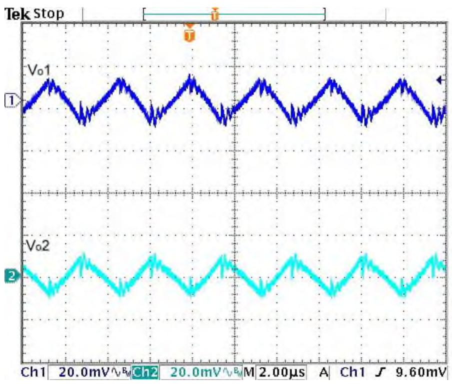
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



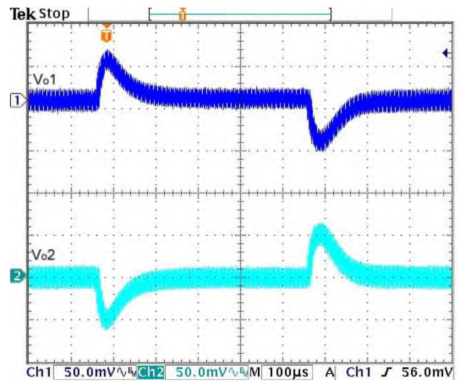
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

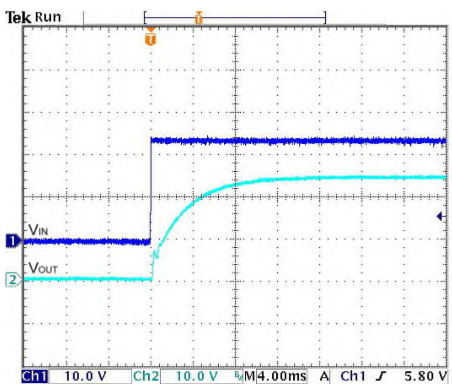
All test conditions are at 25°C.The figures are for PXE30-24D12



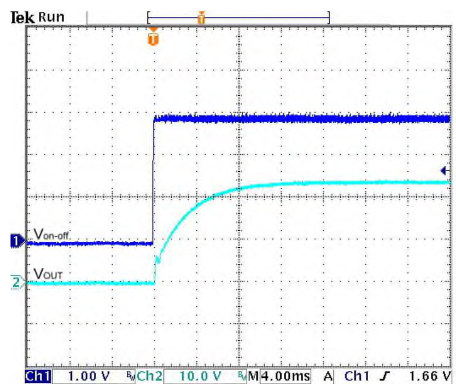
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



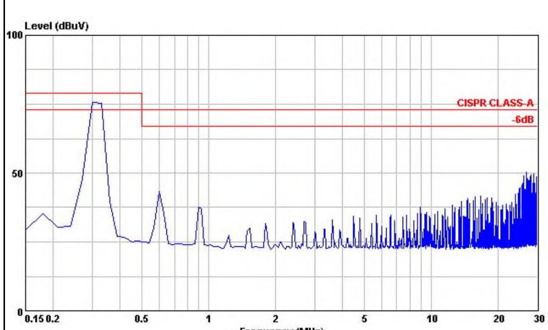
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



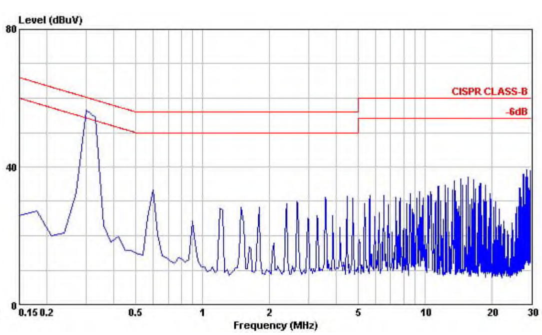
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



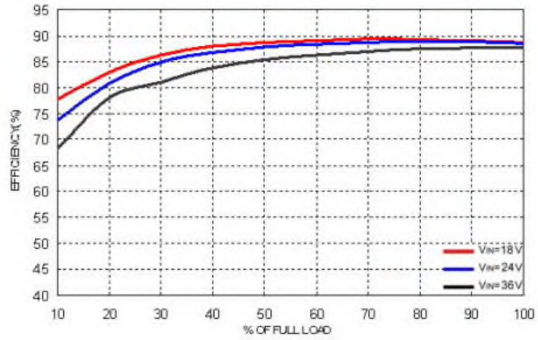
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



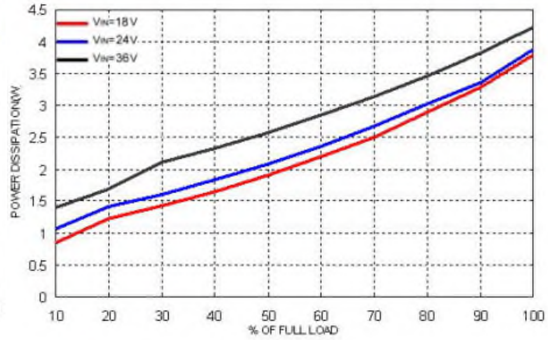
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

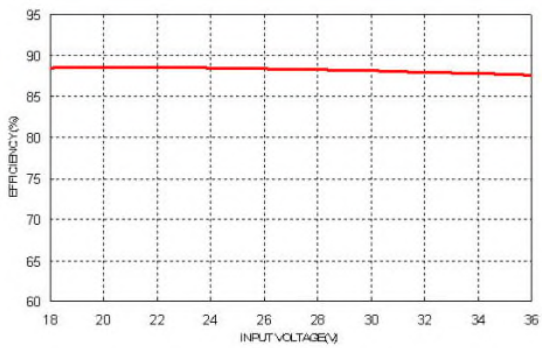
All test conditions are at 25°C.The figures are for PXE30-24D15



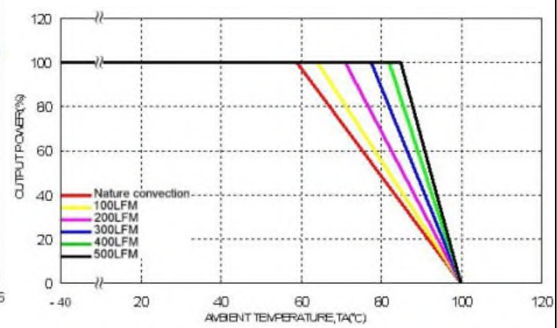
Efficiency Versus Output Current



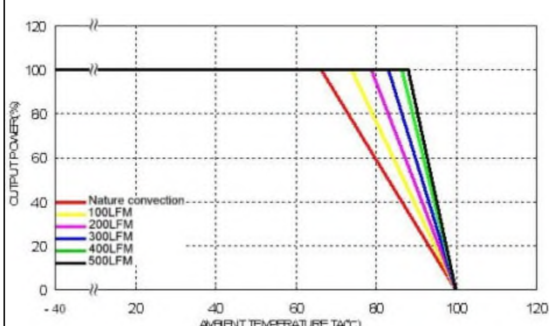
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



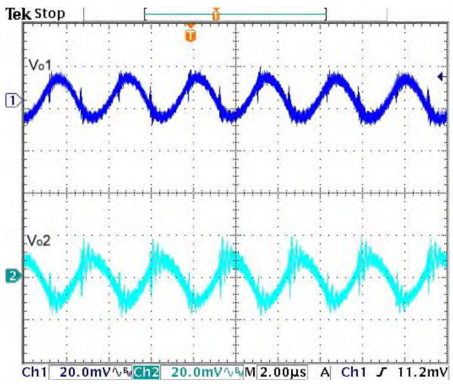
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



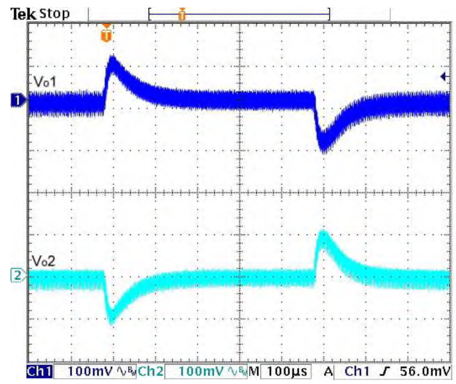
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

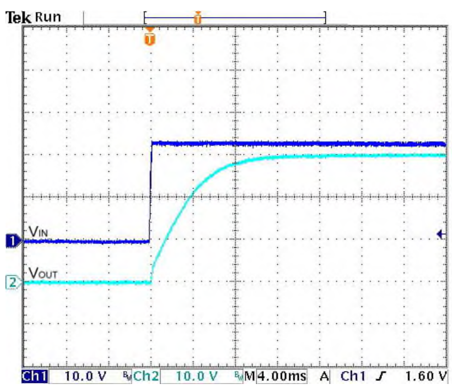
All test conditions are at 25°C.The figures are for PXE30-24D15



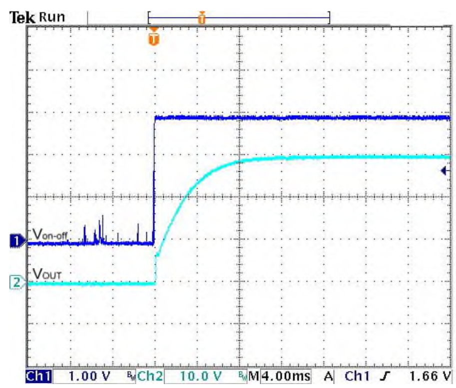
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



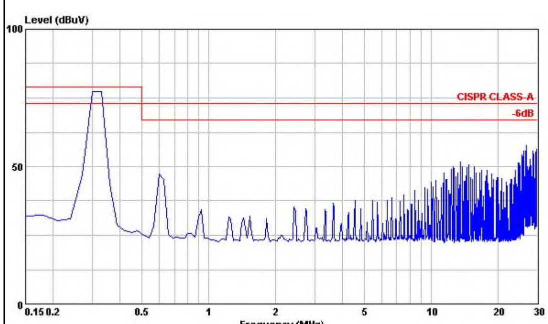
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



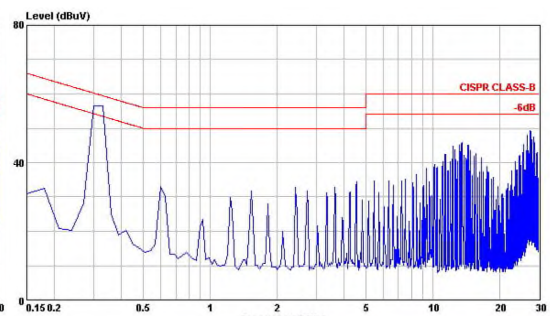
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



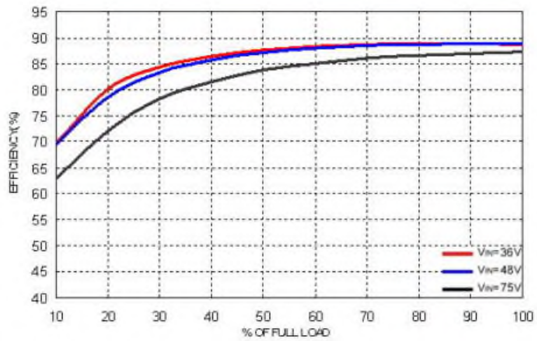
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



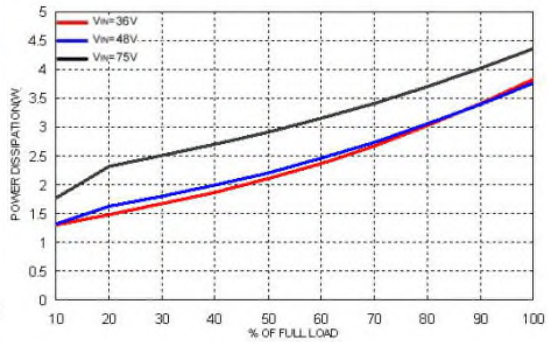
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

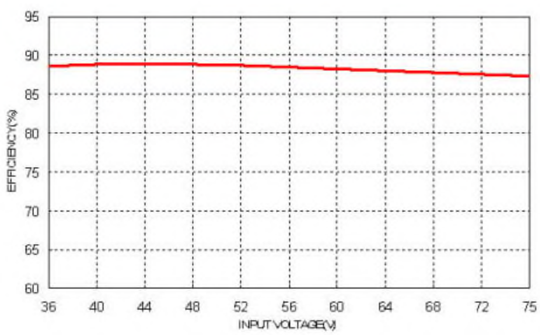
All test conditions are at 25°C.The figures are for PXE30-48D12



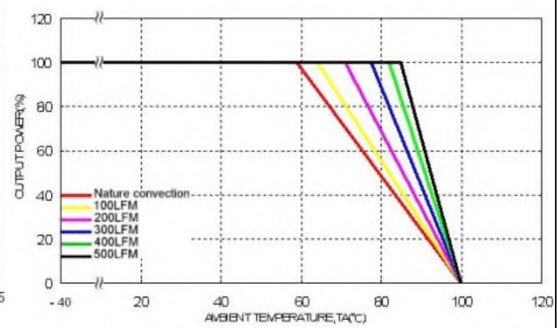
Efficiency Versus Output Current



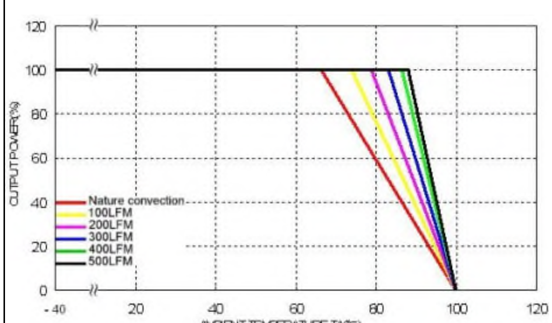
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



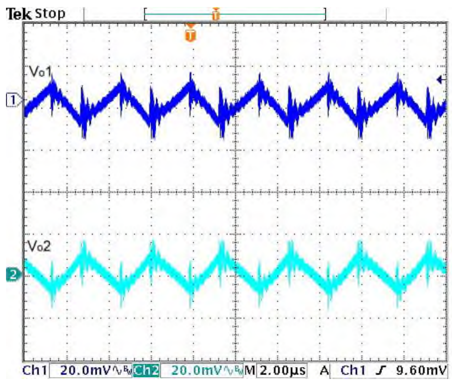
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



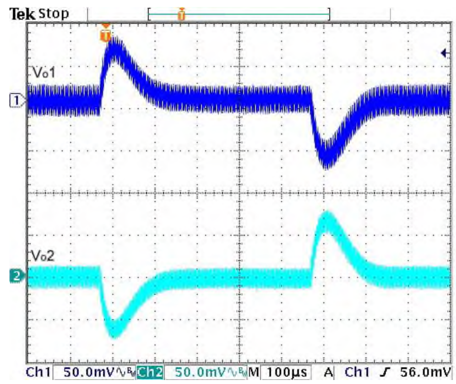
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

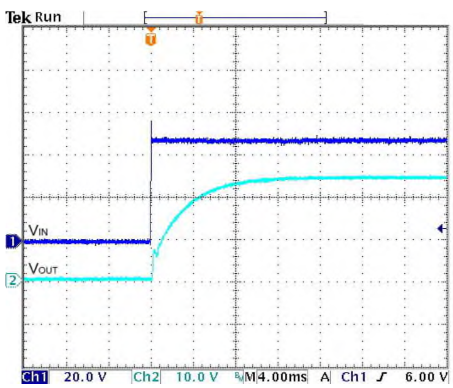
All test conditions are at 25°C.The figures are for PXE30-48D12



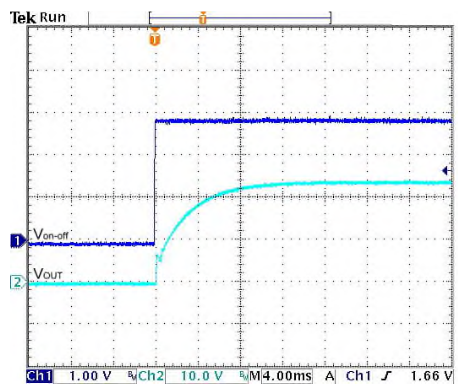
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



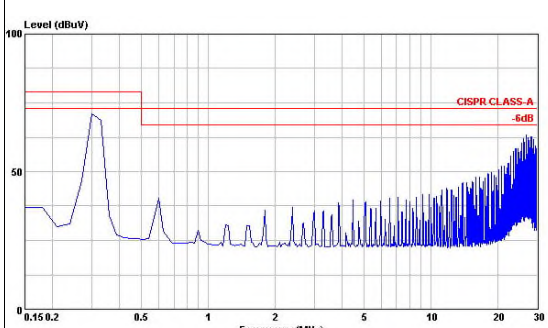
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



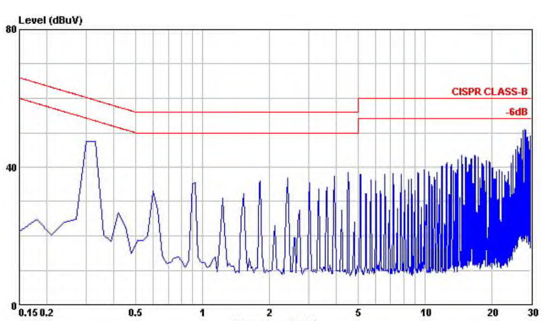
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



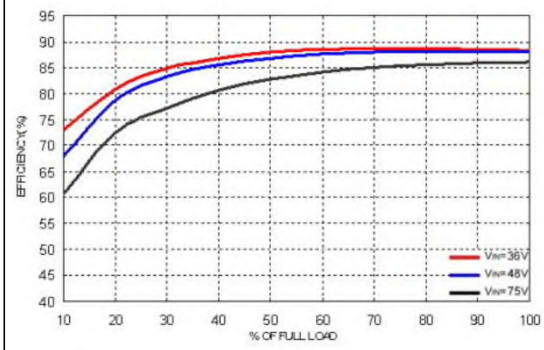
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



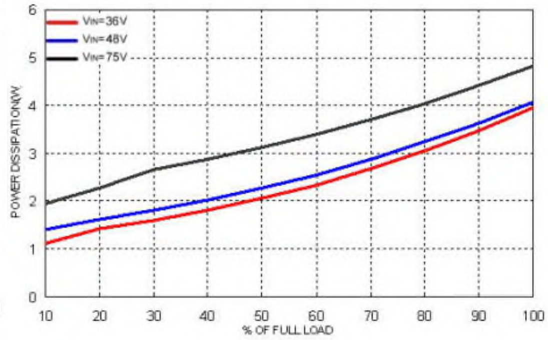
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

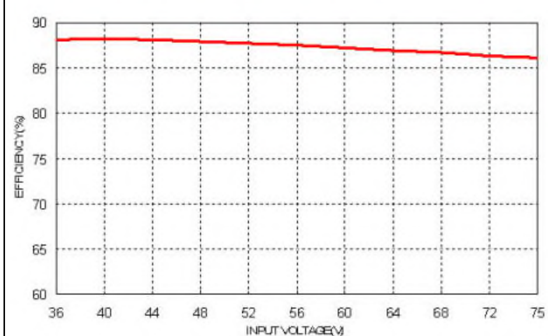
All test conditions are at 25°C.The figures are for PXE30-48D15



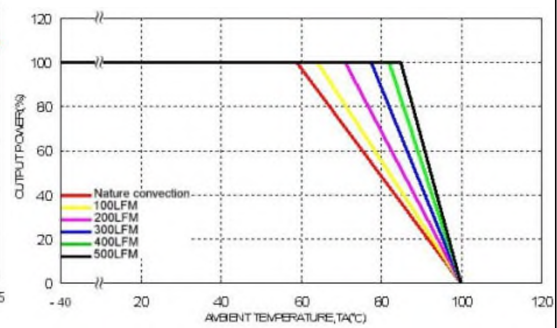
Efficiency Versus Output Current



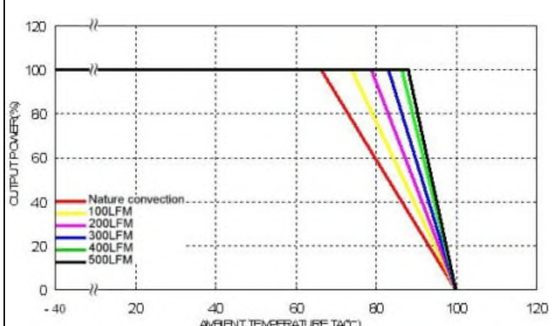
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



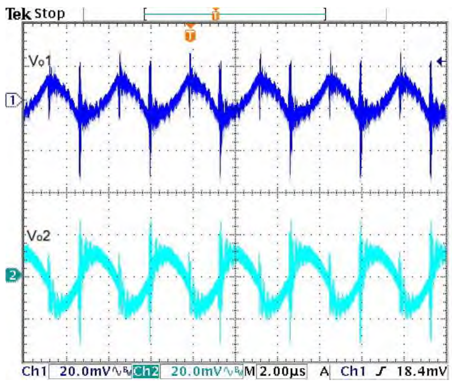
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

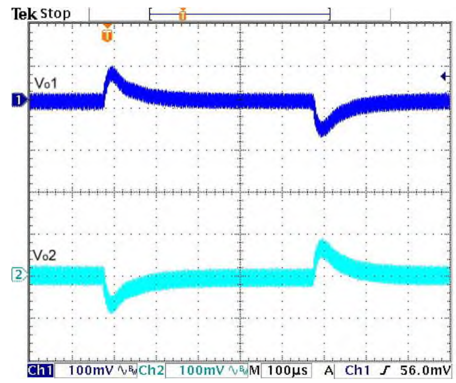
Characteristic Curves (Continued)

All test conditions are at 25°C.The figures are for PXE30-48D15



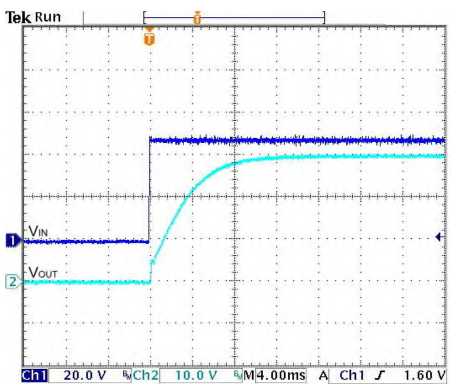
Typical Output Ripple and Noise.

Vin=Vin(nom), Full Load



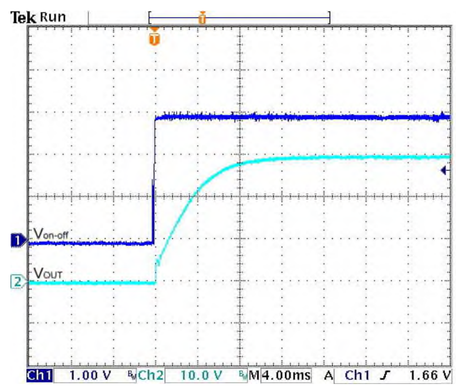
Transient Response to Dynamic Load Change from

100% to 75% to 100% of Full Load ; Vin=Vin(nom)



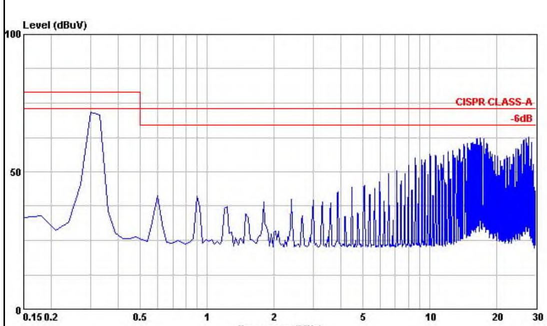
Typical Input Start-Up and Output Rise Characteristic

Vin=Vin(nom), Full Load



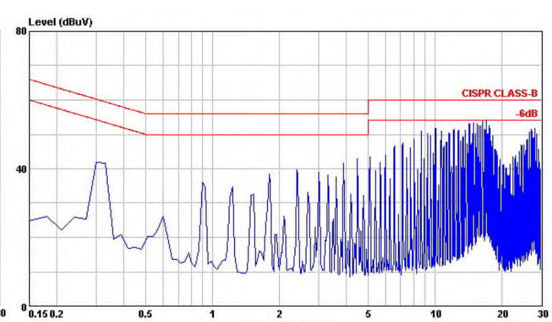
Using ON/OFF Voltage Start-Up and Vo Rise Characteristic

Vin=Vin(nom), Full Load



Conduction Emission of EN55022 Class A

Vin=Vin(nom), Full Load

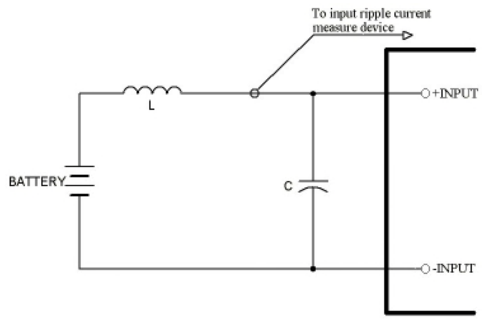


Conduction Emission of EN55022 Class B

Vin=Vin(nom), Full Load

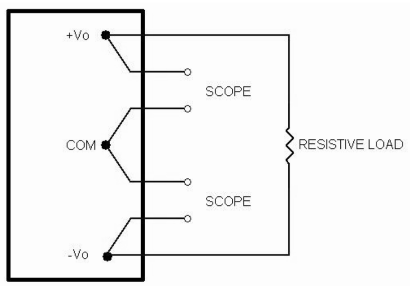
Test Configurations

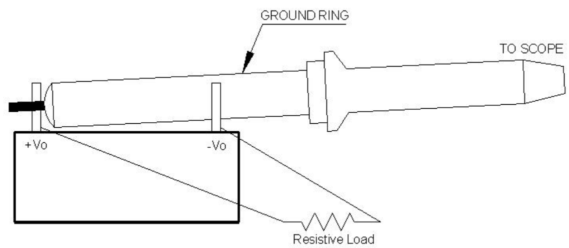
Input reflected-ripple current measurement test:



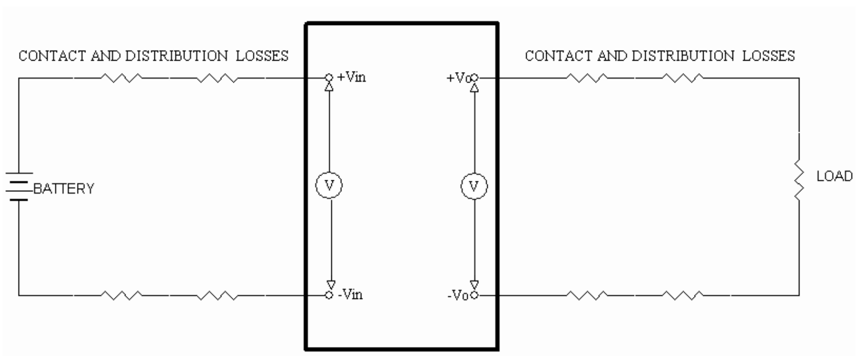
Component	Value	Voltage	Reference
L	12µH	----	----
C	220µF	100V	Aluminum Electrolytic Capacitor

Peak-to-peak output ripple & noise measurement test:





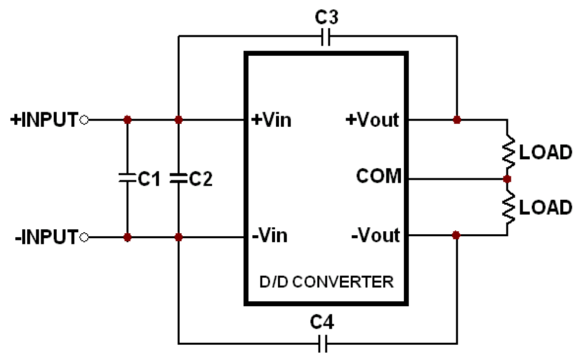
Output voltage and efficiency measurement test:



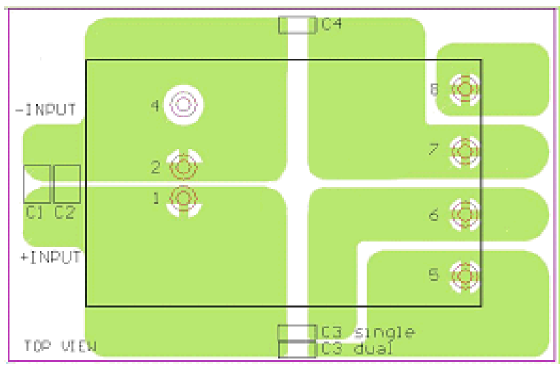
Note: All measurements are taken at the module terminals.

$$Efficiency = \left(\frac{V_o \times I_o}{V_{in} \times I_{in}}\right) \times 100\%$$

EMC Considerations



Suggested Schematic for EN55022 Conducted Emission Class A Limits



Recommended Layout with Input Filter

To meet conducted emissions EN 55022 CLASS A the following components are needed:

PXE30-12Dxx

Component	Value	Voltage	Reference
C1	6.8µF	50V	1812 MLCC
C3、C4	1000pF	2KV	1808 MLCC

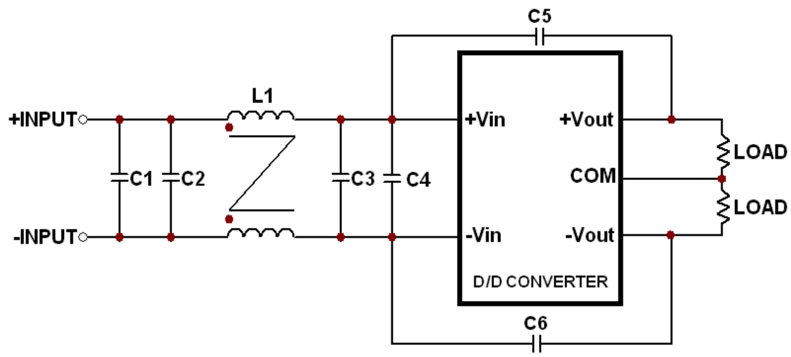
PXE30-24Dxx

Component	Value	Voltage	Reference
C1	6.8µF	50V	1812 MLCC
C3:C4	1000pF	2KV	1808 MLCC

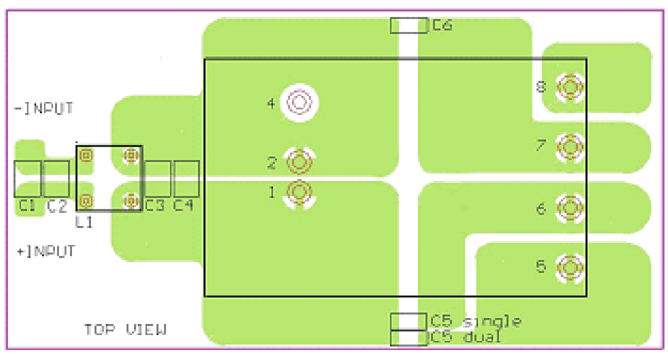
PXE30-48Dxx

Component	Value	Voltage	Reference
C1	2.2µF	100V	1812 MLCC
C3:C4	1000pF	2KV	1808 MLCC

EMC Considerations (Continued)



Suggested Schematic for EN55022 Conducted Emission Class B Limits



Recommended Layout with Input Filter

To meet conducted emissions EN55022 CLASS B needed the following components：

PXE30-12Dxx

Component	Value	Voltage	Reference
C1:C3	4.7µF	50V	1812 MLCC
C5:C6	1000pF	2KV	1808 MLCC
L1	450µH	----	Common Choke

PXE30-24Dxx

Component	Value	Voltage	Reference
C1:C3	6.8µF	50V	1812 MLCC
C5:C6	1000pF	2KV	1808 MLCC
L1	450µH	----	Common Choke

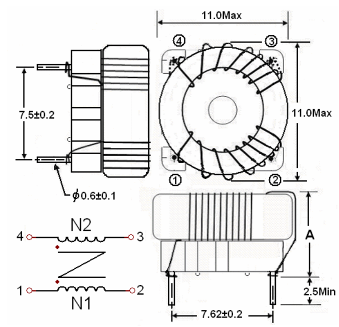
PXE30-48Dxx

Component	Value	Voltage	Reference
C1:C2	2.2µF	100V	1812 MLCC
C3:C4	2.2µF	100V	1812 MLCC
C5:C6	1000pF	2KV	1808 MLCC
L1	450µH	----	Common Choke

EMC Considerations (Continued)

This Common Choke L1 is defined as follows:

- L:450μH±35% / DCR:25mΩ, max
  A height:9.8 mm, Max
- All dimensions in millimeters



Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Input external L-C filter is recommended to minimize input reflected ripple current. The inductor has a simulated source impedance of 12μH and capacitor is Nippon chemi-con KY series 220μF/100V. The capacitor must as close as possible to the input terminals of the power module for lower impedance.

Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all converters. Normally, overload current is maintained at approximately 150 percent of rated current for PXF40-xxSxx series.

Hiccup-mode is a method of operation in a converter whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the converter to restart when the fault is removed. There are other ways of protecting the converter when it is over-loaded, such as the maximum current limiting or current foldback methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of these devices may exceed their specified limits. A protection mechanism has to be used to prevent these power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the converter for a given time and then tries to start up the converter again. If the over-load condition has been removed, the converter will start up and operate normally; otherwise, the controller will see another over-current event and will shut off the converter again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

Output Over Voltage Protection

The output over-voltage protection consists of a Zener diode that monitors the voltage on the output terminals. If the voltage on the output terminals exceeds the over-voltage protection threshold, then the Zener diode clamps the output voltage.

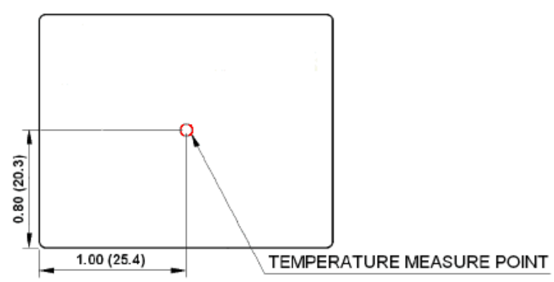
Short Circuit Protection

Continuous, hiccup and auto-recovery mode.

During a short circuit, the converter shut s down. The average current during this condition will be very low .

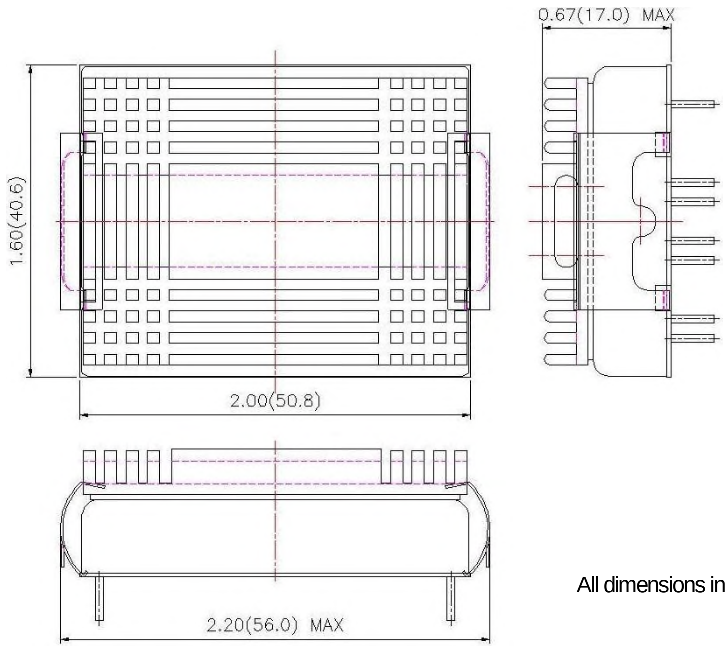
Thermal Consideration

The power module operates in a variety of thermal environments. However, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 100°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 100°C. Although the maximum point temperature of the power modules is 100°C, limiting this temperature to a lower value will yield higher reliability.



Heat Sink Consideration

Optional heat-sink (HAPXE) and optional heat sink clip (HAPXECLIP); two clips required when used.

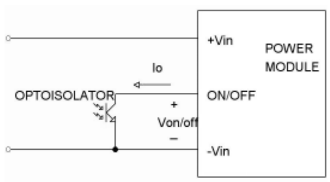


All dimensions in millimeters

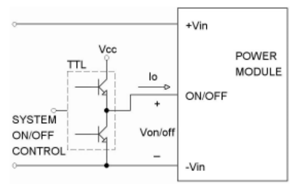
Remote ON/OFF Control

The Remote ON/OFF Pin is used to turn on and off the DC/DC power module. The user must use a switch to control the logic voltage (high or low level) of the pin referenced to -Vin. The switch can be an open collector transistor, FET and Opto-Coupler. The switch must be capable of sinking up to 0.5 mA at low-level logic voltage. High-level logic of the ON/OFF signal (maximum voltage): the allowable leakage current of the switch at 12V is 0.5mA.

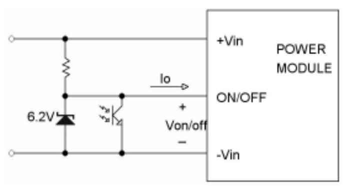
Remote ON/OFF Implementation Circuits



Isolated-Clontrol Remote ON/OFF

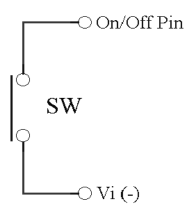


Level Control Using TTL Output

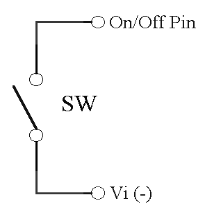


Level Control Using Line Voltage

Positive Logic:

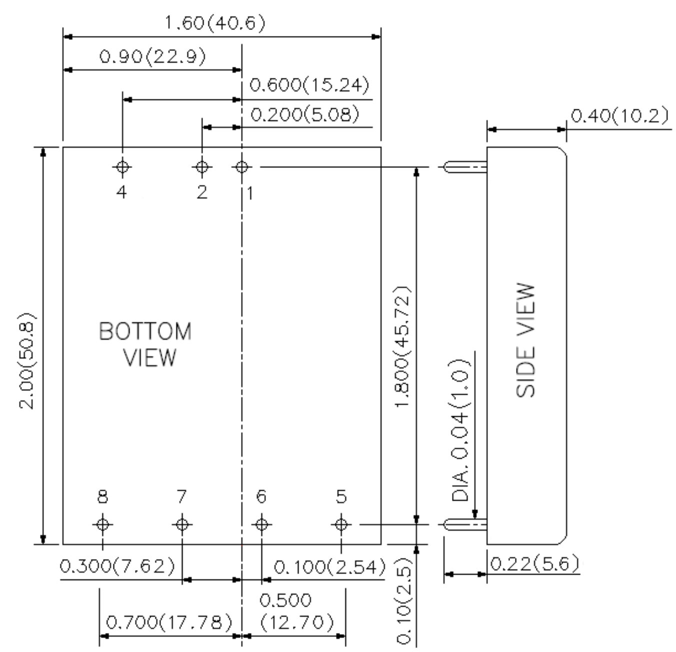


When PXE30 module is turned off at Low-level logic



When PXE30 module is turned on at High-level logic

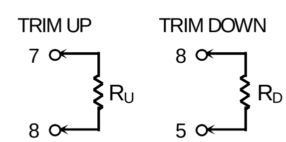
Mechanical Data



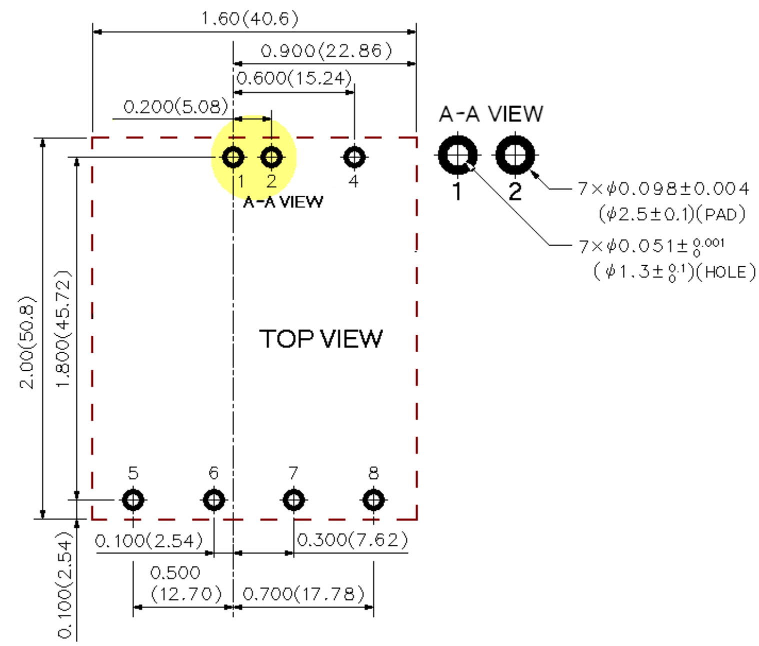
PIN CONNECTION	
PIN	FUNCTION
1	+INPUT
2	-INPUT
4	CTRL
5	+OUTPUT
6	COMMON
7	-OUTPUT
8	TRIM

EXTERNAL OUTPUT TRIMMING

Output can be externally trimmed by using the method shown below.

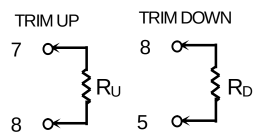


Recommended Pad Layout



Output Voltage Adjustment

Output voltage set point adjustment allows the user to increase or decrease the output voltage set point of a module. This is accomplished by connecting an external resistor between the TRIM pin and either the Vo(+) or Vo(-) pins. With an external resistor between the TRIM and Vo(-) pin, the output voltage set point increases. With an external resistor between the TRIM and Vo(+) pin, the output voltage set point decreases.



TRIM TABLE

PXE30-xxD12

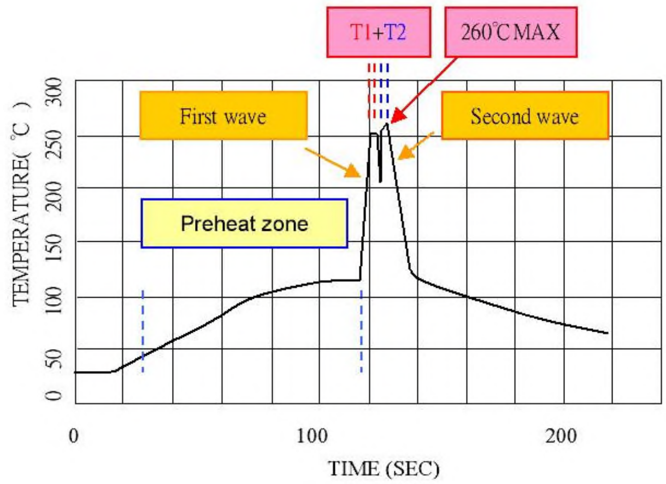
Trim up (%)	1	2	3	4	5	6	7	8	9	10
V_{OUT} (Volts)=	±12.12	±12.24	±12.36	±12.48	±12.6	±12.72	±12.84	±12.96	±13.08	±13.2
R_U (K OhmS)=	218.21	98.105	58.07	38.052	26.042	18.035	12.316	8.026	4.69	2.021
Trim down (%)	**1**	**2**	**3**	**4**	**5**	**6**	**7**	**8**	**9**	**10**
V_{OUT} (Volts)=	±11.88	±11.76	±11.64	±11.52	±11.4	±11.28	±11.16	±11.04	±10.92	±10.8
R_D (K OhmS)=	273.44	123.02	72.874	47.803	32.76	22.732	15.568	10.196	6.017	2.675

PXE30-xxD15

Trim up (%)	1	2	3	4	5	6	7	8	9	10
V_{OUT} (Volts)=	±15.15	±15.3	±15.45	±15.6	±15.75	±15.9	±16.05	±16.2	±16.35	±16.5
R_U (K OhmS)=	268.29	120.64	71.429	46.822	32.058	22.215	15.184	9.911	5.81	2.529
Trim down (%)	**1**	**2**	**3**	**4**	**5**	**6**	**7**	**8**	**9**	**10**
V_{OUT} (Volts)=	±14.85	±14.7	±14.55	±14.4	±14.25	±14.1	±13.95	±13.8	±13.65	±13.5
R_D (K OhmS)=	337.71	152.02	90.126	59.178	40.609	28.23	19.387	12.756	7.598	3.471

Soldering and Reflow Consideration

Lead free wave solder profile for PXE30-xxDxx DIP type



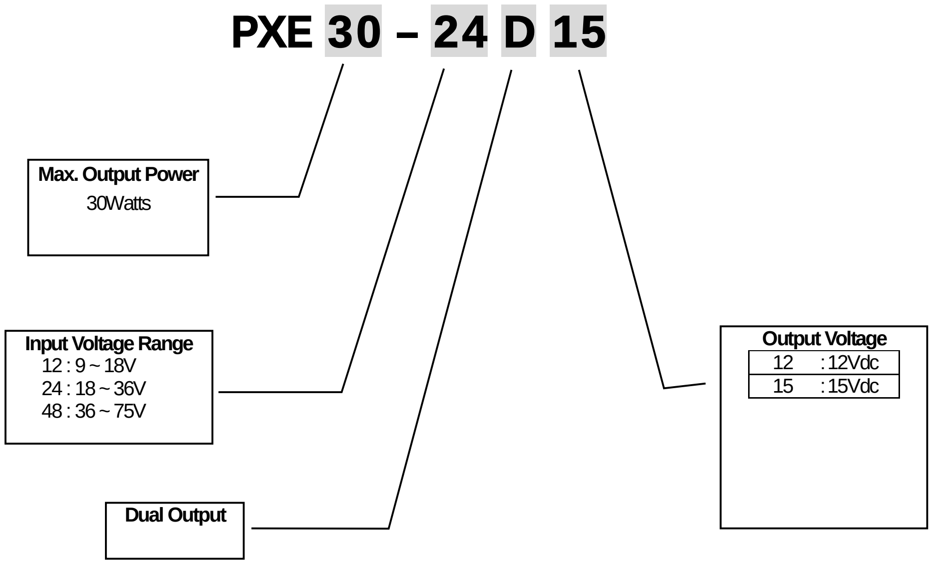
Zone	Reference Parameter
Preheat zone	Rise temp. speed : 3°C / sec max. Preheat temp. : 100~130°C
Actual heating	Peak temp. : 250~260°C Peak time (T1+T2 time) : 4~6 sec

Reference Solder: Sn-Ag-Cu/Sn-Cu
Hand Welding: Soldering iron-Power 90W
Welding Time:2-4 sec
Temp.:380-400 °C

Packaging Information

12 PCS per TUBE

Part Number Structure



Model Number	Input Range	Output Voltage	Output Current		Input Current		Eff (3) (%)
			Min. load	Full Load	No load(1)	Full Load(2)	
PXE30-12D12	9 – 18 VDC	12 VDC	0mA	1250mA	60mA	3012mA	87
PXE30-12D15	9 – 18 VDC	15 VDC	0mA	1000mA	40mA	3012mA	87
PXE30-24D12	18 – 36 VDC	12 VDC	0mA	1250mA	50mA	1488mA	88
PXE30-24D15	18 – 36 VDC	15 VDC	0mA	1000mA	35mA	1488mA	88
PXE30-48D12	36 – 75 VDC	12 VDC	0mA	1250mA	45mA	744mA	88
PXE30-48D15	36 – 75 VDC	15 VDC	0mA	1000mA	50mA	744mA	88

Note 1. Typical value at nominal input voltage and no load.
Note 2. Maximum value at nominal input voltage and full load.
Note 3. Typical value at nominal input voltage and full load.

Safety and Installation Instruction

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a slow-blow fuse with maximum rating of 6A. Based on the information provided in this data sheet on Inrush energy and maximum DC input current; the same type of fuse with lower rating can be used. Refer to the fuse manufacturer's data for further information.

MTBF and Reliability

The MTBF of PXE30-xxDxx DC/DC converters has been calculated using:

Bellcore TR-NWT-000332 Case I: 50% stress, Operating Temperature at 40°C (Ground fixed and controlled environment). The resulting figure for MTBF is 1.316×10^{6} hours.

MIL-HDBK-217F NOTICE2 FULL LOAD, Operating Temperature at 25°C ℃. The resulting figure for MTBF is 3.465×10^{5} hours.